



**Solid State Devices, Inc.**

14830 Valley View Blvd \* La Mirada, Ca 90638

Phone: (562) 404-7855 \* Fax: (562) 404-1773

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**DESIGNER'S DATA SHEET**

**Features:**

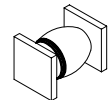
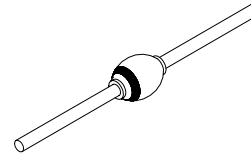
- Hyper Fast Recovery: 40 nsec maximum
- PIV to 900 Volts, Consult Factory
- Hermetically Sealed
- Void Free Construction
- For High Efficiency Applications
- Replaces UES 1104, UES1106, IN6624
- TX, TXV, S Level screening Available

**SHF1104 & SHF1104SMS  
thru  
SHF1109 & SHF1109SMS**

**1 AMP  
400 - 900 V  
Hyper Fast Rectifier**

Axial Lead Diode

SMS



Maximum Ratings		Symbol	Value	Units
<b>Peak Repetitive Reverse and DC Blocking Voltage</b>	SHF1104	$V_{RRM}$ $V_{RSM}$ $V_R$	400	Volts
	SHF1106		600	
	SHF1108		800	
	SHF1109		900	
<b>Average Rectified Forward Current</b> (Resistive Load, 60 hz Sine Wave, $T_A = 25^\circ\text{C}$ )		$I_o$	1.0	Amps
<b>Peak Surge Current</b> (8.3 ms Pulse, Half Sine Wave, $T_A = 25^\circ\text{C}$ )		$I_{FSM}$	20	Amps
<b>Operating &amp; Storage Temperature</b>		$T_{OP}$ & $T_{STG}$	-65 to +175	$^\circ\text{C}$
<b>Maximum Thermal Resistance</b>	Junction to Leads, L = 3/8	$R_{\theta JE}$	35	$^\circ\text{C}/\text{W}$
	Junction to Tabs		28	

**NOTE:** All specifications are subject to change without notification. SCD's for these devices should be reviewed by SSDI prior to release.

**DATA SHEET #: RH0111E**

**DOC**



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**SHF1104 & SHF1104SMS  
 thru  
 SHF1109 & SHF1109SMS**

Electrical Characteristic	Symbol	Max	Units
<b>Instantaneous Forward Voltage Drop</b> ( $I_F = 1A_{DC}$ , $T_A = 25^\circ C$ pulsed)	$V_F$	1.35	$V_{DC}$
<b>Instantaneous Forward Voltage Drop</b> ( $I_F = 1A_{DC}$ , $T_A = -55^\circ C$ pulsed)	$V_F$	1.5	$V_{DC}$
<b>Reverse Leakage Current</b> (Rated $V_R$ , $T_A = 25^\circ C$ pulsed)	$I_R$	10	$\mu A$
<b>Reverse Leakage Current</b> (Rated $V_R$ , $T_A = 100^\circ C$ pulsed)	$I_R$	1	mA
<b>Reverse Recovery Time</b> ( $I_F = 500mA$ , $I_R = 1A$ , $I_{RR} = 250mA$ , $T_A = 25^\circ C$ )	$t_{RR}$	40	nsec
<b>Junction Capacitance</b> ( $V_R = 10V_{DC}$ , $T_A = 25^\circ C$ , $f = 1MHz$ )	$C_J$	22	pF

**Case Outline: (Axial)**

DIM	MIN	MAX
A	0.100"	0.130"
B	0.130"	0.180"
C	0.027"	0.033"
D	1.00"	--

**Case Outline: (SMS)**

DIM	MIN	MAX
A	0.127"	0.140"
B	0.180"	0.230"
C	0.020"	0.030"
D	0.002"	--